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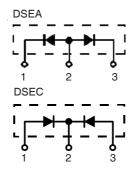
DSEA 59-06BC DSEC 59-06BC

HiPerFRED™ Epitaxial Diode ISOPLUS220™

Electrically Isolated Back Surface

Preliminary Data Sheet

V _{RSM}	V _{RRM}	Туре
600	600	DSEA 59-06BC DSEC 59-06BC



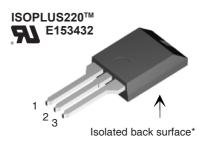
Conditions	Maximum Ratings	S
Lead current limit T _C = 105°C; rectangular, d = 0.5	45 30	A A
$T_{VJ} = 45^{\circ}C; t_p = 10 \text{ ms (50 Hz), sine}$	200	Α
$T_{VJ} = 25$ °C; non-repetitive $I_{AS} = 1.3$ A; L = 180 μ H	0.2	mJ
V _A = 1.5·V _R typical; f = 10 kHz; repetitive	0.1	Α
	-40+175	°C
	175 -40+150	°C
1.6 mm (0.063 in) from case for 10 s	260	°C
$T_C = 25^{\circ}C$	136	W
50/60 Hz RMS; I _{ISOL} ≤ 1 mA	2500	V~
Mounting force	1165 / 2.515	N / Ib
typical	2	g
	Lead current limit $T_{C} = 105^{\circ}\text{C}; \text{ rectangular, } d = 0.5$ $T_{VJ} = 45^{\circ}\text{C}; \text{ t}_{p} = 10 \text{ ms (50 Hz), sine}$ $T_{VJ} = 25^{\circ}\text{C}; \text{ non-repetitive}$ $I_{AS} = 1.3 \text{ A}; L = 180 \ \mu\text{H}$ $V_{A} = 1.5 \cdot V_{R} \text{ typical; } f = 10 \text{ kHz; repetitive}$ $1.6 \text{ mm (0.063 in) from case for 10 s}$ $T_{C} = 25^{\circ}\text{C}$ $50/60 \text{ Hz RMS; } I_{ISOL} \leq 1 \text{ mA}$ Mounting force	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$

Symbol	Conditions	Charact typ.	eristic V max.	alues/
I _R ②	$\begin{split} T_{VJ} &= 25^{\circ}\text{C} & V_{R} = V_{RRM} \\ T_{VJ} &= 150^{\circ}\text{C} & V_{R} = V_{RRM} \end{split}$		250 2	μA mA
V _F ③	$I_F = 30 \text{ A};$ $T_{VJ} = 150^{\circ}\text{C}$ $T_{VJ} = 25^{\circ}\text{C}$		1.56 2.51	V
R _{thJC}		0.6	1.1	K/W K/W
t _{rr}	$I_F = 1 \text{ A}; -\text{di/dt} = 200 \text{ A/µs};$ $V_R = 30 \text{ V}; T_{VJ} = 25^{\circ}\text{C}$	30		ns
I _{RM}	$V_R = 100 \text{ V};$ $I_F = 50 \text{ A}; -di_F/dt$ $T_{VJ} = 100^{\circ}\text{C}$	= 100 A/µs 4		Α

Notes: Data given for $T_{VJ} = 25^{\circ}C$ and per diode unless otherwise specified

- ① Average current per diode may be limited by center lead RMS current limit when both diodes are conducting.
- \odot Pulse test: pulse Width = 5 ms, Duty Cycle < 2.0 %

 $I_{FAV} = 2x30 A$ $V_{RRM} = 600 V$ $t_{rr} = 35 ns$



Features

- Silicon chip on Direct-Copper-Bond substrate
- High power dissipation
- Isolated mounting surface
- 2500V electrical isolation
- Low cathode to tab capacitance (<15pF)
- · Planar passivated chips
- · Very short recovery time
- Extremely low switching losses
- Low I_{RM}-values
- · Soft recovery behaviour
- Epoxy meets UL 94V-0

Applications

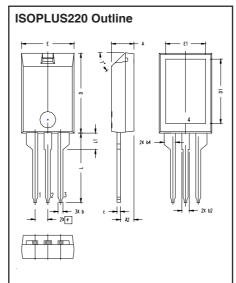
- Antiparallel diode for high frequency switching devices
- · Antisaturation diode
- · Snubber diode
- Free wheeling diode in converters and motor control circuits
- Rectifiers in switch mode power supplies (SMPS)
- Inductive heating
- Uninterruptible power supplies (UPS)
- · Ultrasonic cleaners and welders

Advantages

- Avalanche voltage rated for reliable operation
- · Soft reverse recovery for low EMI/RFI
- Low I_{RM} reduces:
- Power dissipation within the diode
- Turn-on loss in the commutating switch

See DSEP 29-06B data sheet for characteristic curves





MY2	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
Α	.157	.197	4.00	5.00
A2	.098	.118	2.50	3.00
b	.035	.051	0.90	1.30
b2	.049	.065	1.25	1.65
b4	.093	.100	2.35	2.55
С	.028	.039	0.70	1.00
D	.591	.630	15.00	16.00
D1	.472	.512	12.00	13.00
Ε	.394	.433	10.00	11.00
E1	.295	.335	7.50	8.50
е	.100 BASIC		2.55 BASIC	
L	.512	.571	13.00	14.50
L1	.118	.138	3.00	3.50
T.			42.5°	47.5°

Notes:

DSEA 29

- 1. Lead 1 = Cathode
- 2. Lead 2 = Common Anode
- 3. Lead 3 = Cathode

DSEC 29

- 1. Lead 1 = Anode 2. Lead 2 = Common Cathode
- 3. Lead 3 = Anode

Back surface 4 is electrically isolated from leads 1, 2 and 3